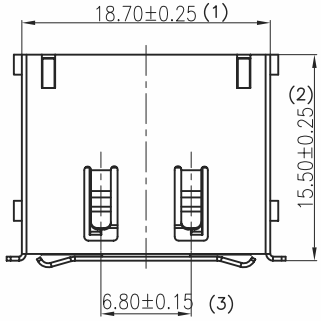
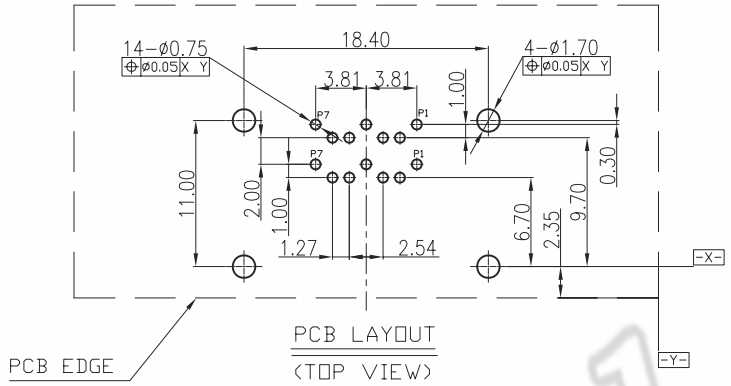
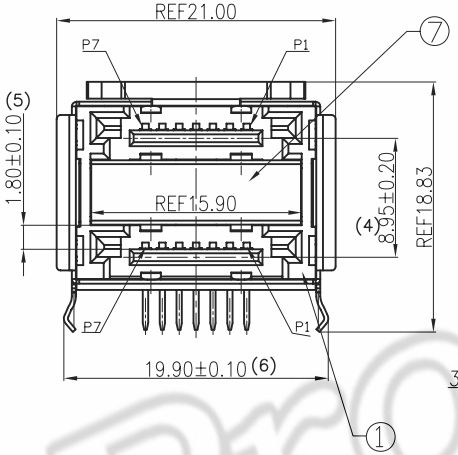
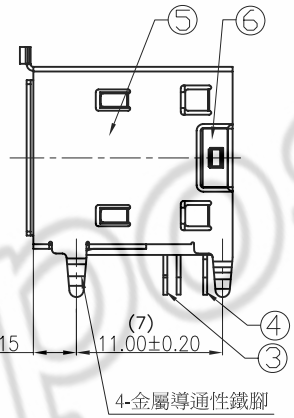
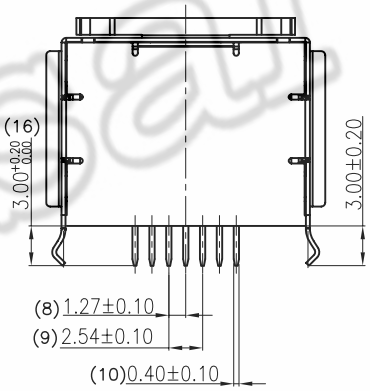
REV	ECN.NO:	BY	DATE
A0	NEW DWG	姜文斌	10.10.08

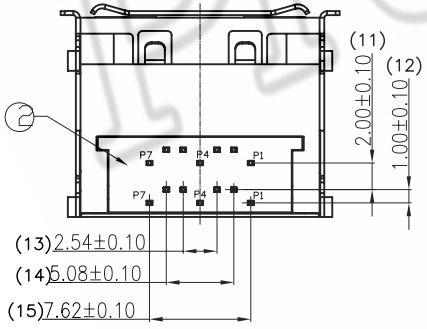


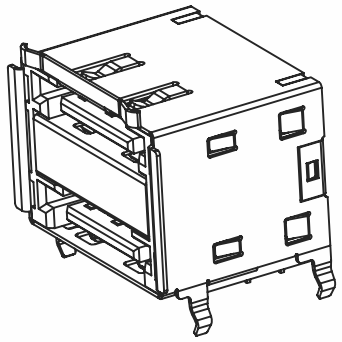












NOTES:

1. MATERIAL:
   - 1.1 HOUSING&COVER: HIGH TEMPERATURE THERMOPLASTIC WITH 30%G.F;94V-0 COLOR:SEE NOTES 6
   - 1.2 CONTACT:COPPER ALLOY
   - 1.3 SPRING:COPPER ALLOY
   - 1.4 SHELL:COPPER ALLOY
2. FINISH:
   - 2.1 CONTACT:
     - GOLD PLATED(SEE TABLE) ON CONTACT AREA.
     - 2.54um [100u"] MIN.TIN PLATED ON SOLDER TAIL AREA.
     - 1.27um [50u"] MIN. NICKEL UNDER-PLATED OVERALL.
   - 2.2 SPRING:
     - 1.27um [50u"] MIN. NICKEL UNDER-PLATED OVERALL.
   - 2.3 SHELL:
     - 1.27um [50u"] MIN. NICKEL UNDER-PLATED OVERALL.
3. RECOMMENDED P.C.B THICKNESS : 1.6mm
4. OTHER GENERAL SPEC. TO REFER : SAT SERIES SPEC.
5. FOR WAVE SOLDERING LEAD-FREE PROCESS
6. 301114-0121-X X X
   - R:RoHS
   - MATERIAL:
     - 7: PA46 COLOR:RED/185C
   - PLATING:
     - 1: Au1u"

NO:	DESCRIPTION	MATERIAL	COLOR	REMARK
7	SPRING	SEE PART DRAWING		NI PLATED
6	SHELL	SEE PART DRAWING		NI PLATED
5	SHELL	SEE PART DRAWING		NI PLATED
4	CONTACT	SEE PART DRAWING		GOLD/TIN PLATED
3	CONTACT	SEE PART DRAWING		GOLD/TIN PLATED
2	COVER	SEE PART DRAWING	SEE PART DRAWING	UL 94V-0
1	HOUSING	SEE PART DRAWING	SEE PART DRAWING	UL 94V-0

TABLE

NO:	PART NO:	PLATING	MATERIAL	REMARK
1	301114-0121-17R	Au1u"	PA46/185C	RoHS

COPLIANCE WITH THE REQUIEMENT ☑ RoHS ☐ HF ☐ SONY00259 ☐ OTHER
※ NO USING RESTRICTED AND BANNED SUBSTANCE

CUSTOMER DRAWING			
-TOLERANCES- UNLESS OTHERWISE SPECIFIED			
X.X	±0.35	X.X°	±3°
X.XX	±0.25	X.XX°	±2°
X.XXX	±0.15	X.XXX°	±1°

Liteconn Co.,Ltd.

APPD:

CHECK:

DRAW: 姜文斌

TITLE: 2XESATA90度DIP型鐵腳K腳

DWG NO: 301114-0121-XXX

DATE	SCALE	UNIT	PAGE
2010.10.08	1:1	MM	1/1

Proposal Only